SCAS536B - SEPTEMBER 1995 - REVISED SEPTEMBER 1996

- EPIC ™ (Enhanced-Performance Implanted CMOS) 1-μm Process
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Standard Plastic (N) and Ceramic (J) DIPS

description

The 'AC08 are quadruple 2-input positive-AND gates. These devices perform the Boolean function $Y = A \bullet B$ or $Y = \overline{A} + \overline{B}$ in positive logic.

The SN54AC08 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74AC08 is characterized for operation from -40° C to 85° C.

FUNCTION TABLE (each gate)								
INP	UTS	OUTPUT						
Α	В	Y						
н	Н	н						
L	Х	L						
Х	L	L						

logic symbol[†]

	1	&		
1A 1B	2	4	3	1Y
20	4			
1B 2A 2B 3A	5		6	2Y
20	9			
3B	10		8	3Y
	12			
4A 4B	13		11	4Y
4B				

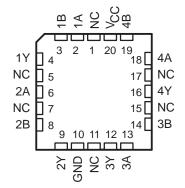
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, DB, J, N, PW, and W packages.

SN54AC08	J OR W PACKAGE
SN74AC08 I	D, DB, N, OR PW PACKAGE
	(TOP VIEW)

1A		U	14	þ	V _{CC} 4B	;
1B	2		13	þ	4B	
1Y	[] 3		12	þ	4A	
2A	4		11	þ	4Y	
2B	5		10		3B	
2Y	6		9		ЗA	
GND	[7		8	þ	3Y	

SN54AC08 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram, each gate (positive logic)





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SCAS536B - SEPTEMBER 1995 - REVISED SEPTEMBER 1996

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Note 1) Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) Continuous output current, I_O ($V_O = 0$ to V_{CC}) Continuous current through V_{CC} or GND Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2)	-0.5 V to V _{CC} + 0.5 V -0.5 V to V _{CC} + 0.5 V ±20 mA ±20 mA ±50 mA ±200 mA): D package
Storage temperature range, T _{stg}	PW package 0.5 W

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.

recommended operating conditions (see Note 3)

			SN54/	SN54AC08		SN74AC08		
			MIN	MAX	MIN	MAX	UNIT	
VCC	Supply voltage		2	6	2	6	V	
		V _{CC} = 3 V	2.1		2.1			
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15		3.15		V	
		$V_{CC} = 5.5 V$	3.85		3.85			
		$V_{CC} = 3 V$		0.9		0.9		
VIL	/IL Low-level input voltage	$V_{CC} = 4.5 V$		1.35		1.35	V	
		V _{CC} = 5.5 V		1.65		1.65		
VI	Input voltage		0	VCC	0	VCC	V	
VO	Output voltage		0	VCC	0	VCC	V	
		$V_{CC} = 3 V$		-12		-12		
IOH	High-level output current	$V_{CC} = 4.5 V$		-24		-24	mA	
		$V_{CC} = 5.5 V$		-24		-24		
		$V_{CC} = 3 V$		12		12		
IOL	Low-level output current	V _{CC} = 4.5 V		24		24	mA	
		V _{CC} = 5.5 V		24		24		
$\Delta t/\Delta v$	Input transition rise or fall rate		0	8	0	8	ns/V	
Тд	Operating free-air temperature		-55	125	-40	85	°C	

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



SCAS536B - SEPTEMBER 1995 - REVISED SEPTEMBER 1996

DADAMETER	TEST CONDITIONS		Т	A = 25°C	C	SN54AC08		SN74AC08		LINUT	
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
		3 V	2.9			2.9		2.9			
	I _{OH} = - 50 μA	4.5 V	4.4			4.4		4.4			
		5.5 V	5.4			5.4		5.4			
Vou	I _{OH} = – 12 mA	3 V	2.56			2.4		2.46		V	
VOH	I _{OH} = – 24 mA	4.5 V	3.86			3.7		3.76		v	
	10H = -24 IIIA	5.5 V	4.86			4.7		4.76			
	I _{OH} = - 50 mA [†]	5.5 V				3.85					
	I _{OH} = – 75 mA [†]	5.5 V						3.85			
		3 V		0.002	0.1		0.1		0.1		
	I _{OL} = 50 μA	4.5 V		0.001	0.1		0.1		0.1		
		5.5 V		0.001	0.1		0.1		0.1		
	I _{OL} = 12 mA	3 V			0.36		0.5		0.44	V	
VOL	le: - 24 mA	4.5 V			0.36		0.5		0.44		
	I _{OL} = 24 mA	5.5 V			0.36		0.5		0.44		
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65				
	I _{OL} = 75 mA [†]	5.5 V							1.65		
II A or B ports	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ	
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			2		40		20	μA	
Ci	$VI = V_{CC}$ or GND	5 V		4.5						pF	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V $\pm\,$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER FROM		FROM TO		T _A = 25°C		SN54AC08		SN74AC08		UNIT
PARAMETER	R (INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A or B	V	1.5	7.5	9.5	1	12.5	1	10	
^t PHL			1.5	7	8.5	1	11.5	1	9	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V $\pm\,$ 0.5 V (unless otherwise noted) (see Figure 1)

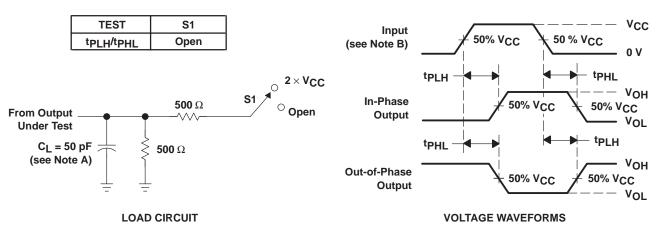
PARAMETER FROM		ОМ ТО		₄ = 25°C	;	SN54	AC08	SN74/	AC08	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A or B	V	1.5	5.5	7.5	1	9	1	8.5	
^t PHL			1.5	5.5	7	1	8.5	1	7.5	ns

operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	$C_L = 50 \text{ pF}, \text{ f} = 1 \text{ MHz}$	20	pF



SCAS536B - SEPTEMBER 1995 - REVISED SEPTEMBER 1996



PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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